ABSTRACT OF THE DISCLOSURE

The present invention discloses a photocurable composition for forming a dielectric layer on a substrate. The dielectric composition of the present invention comprises a first acrylated oligomer, a second acrylated oligomer having a viscosity less than the first acrylated oligomer, a polyolefin wax, an acrylated monomer and a photoinitiator. The first acrylated oligomer as used in the composition of the invention has a viscosity that is less than the second acrylated oligomer. The present invention also discloses a method of making a dielectric coating using the composition of the present invention.